MMIC Surface Mount Power Splitter/Combiner 50Ω



2 Wav-0°

0.7 to 6.0 GHz

The Big Deal

- Ultra-wide bandwidth, 0.7 to 6.0 GHz
- Tiny size, 5 x 5 x 1mm
- High power handling, 2.5W as a splitter



CASE STYLE: DG1677-2

Product Overview

Mini-Circuits' EP2W+ is a MMIC 2-way 0° splitter/combiner designed for wideband operation from 0.7 to 6.0 GHz supporting many applications requiring high performance across a wide frequency range including all the LTE bands through WiMax an WiFi, as well as instrumentation and more. This model provides excellent power handling up to 2.5W (as a splitter) with low insertion loss, good isolation, and low phase and amplitude unbalance in a tiny 5x5mm QFN package. Manufactured using GaAs IPD technology, the EP2W+ provides a high level of ESD protection and excellent repeatability.

Key Features

Feature	Advantages
Wideband, 0.7 to 6.0 GHz	One power splitter can be used in all the LTE bands through WiMax and WiFi, saving compo- nent count. Also ideal for wideband applications such as military and instrumentation.
Tiny size, 5 x 5 mm QFN package	Tiny footprint saves space in dense layouts while providing low inductance, repeatable transi- tions, and excellent thermal contact to the PCB.
Excellent power handling • 2.5W as a splitter • 1.7W internal dissipation as a combiner	In power combiner applications, half the power is dissipated internally. EP2W+ is designed to handle 1.7W internal dissipation as a combiner allowing reliable operation without excessive temperature rise. Similar splitters implemented as Wilkinson splitters on PCB require big resistors and additional heat sinking. As a splitter, EP2W+ can handle up to 2.5W in a very small package.
DC Passing up to 0.4A	DC current passing is helpful in applications where both RF & DC need to pass through the DUT, such as antenna mounted hardware.

MMIC Surface Mount **Power Splitter/Combiner** 50Ω



0.7 to 6.0 GHz

Features

- Wide bandwidth, 0.7 to 6.0 GHz
- Excellent amplitude unbalance, 0.1 dB typ. to 6 GHz
- Good phase unbalance, 1 to 3 deg. typ.
- Small size, 5x5 mm
- High ESD level*
- · Aqueous washable
- DC passing

Applications

- WIMAX
- ISM
- Instrumentation
- Radar
- WLAN
- · Satellite communications
- LTE

Electrical Specifications¹ at 25°C

Parameter	Frequency (GHz)	Min.	Тур.	Max.	Unit
Frequency Range		0.7		6.0	GHz
	0.7 - 1.5	_	0.9	1.5	
Insertion Loss ² above 3.0 dB	1.5 - 3.0	_	1.3	1.9	dB
	3.0 - 6.0	_	1.8	2.5	
	0.7 - 1.5	8.6	11.6	-	
Isolation	1.5 - 3.0	16.8	19.8	_	dB
	3.0 - 6.0	16.4	19.4	_	
	0.7 - 1.5	—	0.5	2.5	
Phase Unbalance	1.5 - 3.0	_	0.9	2.9	Degree
	3.0 - 6.0	_	1.7	6.0	
	0.7 - 1.5	—	0.1	0.3	
Amplitude Unbalance	1.5 - 3.0	_	0.1	0.3	dB
	3.0 - 6.0	_	0.1	0.4	
	0.7 - 1.5	_	1.6	_	
VSWR (Port S)	1.5 - 3.0	_	1.5	_	:1
	3.0 - 6.0	—	1.6	_	
	0.7 - 1.5	_	1.3	_	
VSWR (Port 1-2)	1.5 - 3.0		1.3		:1
	3.0 - 6.0		1.4		

1. Tested on Mini-Circuits Test Board TB-880+

2. Insertion Loss Values are de-embedded from Test Board Loss.

Maximum Ratings

Parameter	Ratings			
Operating Temperature	-40°C to 85°C			
Storage Temperature	-65°C to 150°C			
Power Input (as a splitter)	2.5W ³ Max. at 25°C			
Internal Dissipation	1.7W ⁴ Max. at 25°C			
DC Current	0.4A Max.			

3. Derate linearly to 1.25W at 85°C

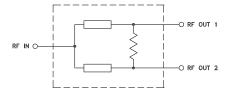
4. Derate linearly to 1.1W at 85°C

Permanent damage may occur if any of these limits are exceeded.

Pad Connections

Function	Pad Number			
SUM PORT	4			
PORT 1	15			
PORT 2	26			
NOT USED, GROUND, EXTERNALLY	1-3, 5-14, 16-25, 27-32 & Paddle			

Simplified Electrical Schematic



* ESD rating Human body model (HBM): Class 2 (2000 to<4000V) in accordance with ANSI/ESD 5.1-2007 Machine model: Class M3 (200 to <4000V) in accordance with ANSI/ESD 5.2-2009



EP2W+

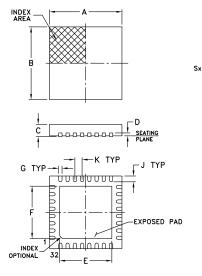
CASE STYLE: DG1677-2

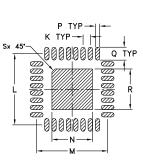
+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

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Outline Drawing





PCB Land Pattern

Suggested Layout, Tolerance to be within $\pm .002$

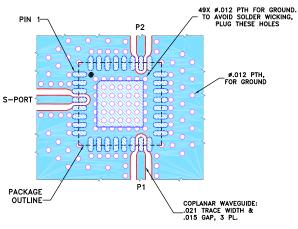
Product Marking



Outline Dimensions (inch)

J)16 .41		H -'	G .009 0.23	F . 142 3.61	E . 142 3.61	.008	C MIN .031 0.79	.039	B .197 5.00	A .197 5.00
wt ms .05	grai		S 0.008 0.20	R .110 2.79	Q .035 0.89	P .012 0.30	.110	M .193 4.90	L . 193 4.90	K .020 0.51

Demo Board MCL P/N: TB-880+ Suggested PCB Layout (PL-488)

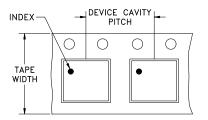


NOTES: 1. TRACE WIDTH PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010"±.001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER THE COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER

BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Tape and Reel (F68) DEVICE ORIENTATION IN T&R



DIRECTION OF FEED

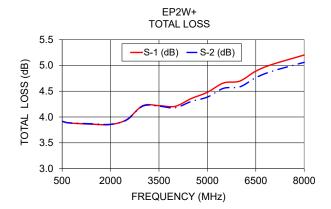
Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note		
12	8	7	Small quantity standard	20 50 100 200 500	
		7	Standard	1000	
		13	Standard	2000 3000 4000	

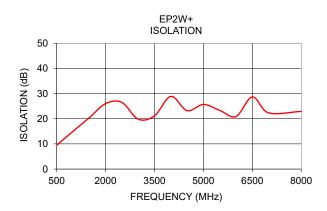


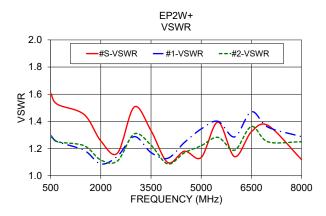
l ypical Performance Data									
Frequency Total Loss1 (GHz) (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR S	VSWR 1	VSWR 2		
	S-1	S-2							
500	3.92	3.92	0.00	9.39	0.01	1.61	1.30	1.29	
700	3.89	3.89	0.00	11.70	0.03	1.53	1.25	1.25	
1500	3.86	3.87	0.01	20.43	0.02	1.45	1.19	1.22	
2000	3.85	3.86	0.00	25.99	0.10	1.26	1.09	1.12	
2500	3.95	3.94	0.01	26.49	0.11	1.17	1.14	1.11	
3000	4.22	4.21	0.01	19.83	0.10	1.51	1.29	1.31	
3500	4.22	4.21	0.01	21.14	0.16	1.33	1.17	1.23	
4000	4.21	4.18	0.03	28.88	0.25	1.10	1.13	1.09	
4500	4.36	4.30	0.06	23.19	0.27	1.18	1.25	1.17	
5000	4.48	4.39	0.09	25.69	0.23	1.13	1.34	1.22	
5500	4.66	4.56	0.10	23.32	0.04	1.40	1.40	1.28	
6000	4.70	4.58	0.11	20.88	0.04	1.14	1.29	1.19	
6500	4.89	4.76	0.13	28.67	0.15	1.32	1.47	1.36	
7000	5.02	4.89	0.13	22.33	0.32	1.37	1.36	1.25	
8000	5.20	5.06	0.14	22.91	0.30	1.12	1.29	1.25	

Typical Performance Data

1. Total Loss = Insertion Loss + 3dB splitter loss.







Additional Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

